# **IGBT** for Automotive **Application**

1200 V, 40 A

### AFGHL40T120RLD

### Description

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction. Provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss, which is AEC Q101 qualified offer the optimum performance for both hard and soft switching topology in automotive application.

#### **Features**

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature:  $T_J = 175$ °C
- Short Circuit Withstand Time 9 us
- Low Saturation Voltage:  $V_{CE(Sat)} = 1.75 \text{ V (Typ.)}$  @  $I_C = 40 \text{ A}$
- 100% of the Parts Tested for I<sub>LM</sub> (Note 2)
- Fast Switching

- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS
  Compliant

  Typical Application

### **Typical Applications**

- Automotive HEV-EV E-Compressor
- Automotive HEV-EV PTC Heater

THIS DEV

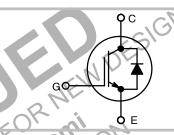
- Automotive HEV–EV Onboard Chargers
- Automotive HEV-EV DC-DC Converters

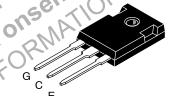


### ON Semiconductor®

#### www.onsemi.com

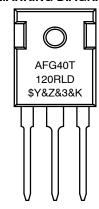
V <sub>CES</sub>	Ic	V <sub>CE(Sat)</sub>
1200 V	40 A	1.75 V (Typ.)





TO-247-3L CASE 340CX

### **MARKING DIAGRAM**



AFG40T120RLD = Specific Device Code \$Y = ON Semiconductor Logo &Z = Assembly Plant Code = 3-Digit Date Code &3 = 2-Digit Lot Traceability Code &K

### **ORDERING INFORMATION**

Device	Package	Shipping
AFGHL40T120RLD	TO-247-3L	30 Units / Rail

### **MAXIMUM RATINGS**

Description	Symbol	Value	Units
Collector to Emitter Voltage	V <sub>CES</sub>	1200	V
Gate to Emitter Voltage	V <sub>GES</sub>	±20	V
Transient Gate to Emitter Voltage		±30	
Collector Current @ T <sub>C</sub> = 25°C (Note 1)	I <sub>C</sub>	48	Α
Collector Current @ T <sub>C</sub> = 100°C		40	
Pulsed Collector Current (Note 2)	I <sub>LM</sub>	160	Α
Pulsed Collector Current (Note 3)	I <sub>CM</sub>	160	Α
Diode Forward Current @ T <sub>C</sub> = 25°C (Note 1)	I <sub>F</sub>	48	Α
Diode Forward Current @ T <sub>C</sub> = 100°C		40	
Pulsed Diode Maximum Forward Current	I <sub>FM</sub>	160	Α
Maximum Power Dissipation @ T <sub>C</sub> = 25°C	P <sub>D</sub>	529	7 w
Maximum Power Dissipation @ T <sub>C</sub> = 100°C		264	
Short Circuit Withstand Time $V_{GE}$ = 15 V, $V_{CE}$ = 600 V, $T_{J}$ = 150°C	SCWT	9) = 3	μs
Operating Junction Temperature / Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C
Maximum Lead Temp. For Soldering Purposes, 1/8" from case for 5 seconds	Tr O	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limited by bond wire.

2. V<sub>CC</sub> = 600 V, V<sub>GE</sub> = 15 V, I<sub>C</sub> = 160 A, R<sub>G</sub> = 15 Ω, Inductive Load, 100% Tested

3. Repetitive rating: pulse width limited by max. Junction temperature.

Rating	Symbol	Max.	Units
Thermal Resistance, Junction to Case, for IGBT	$R_{ heta JC}$	0.28	°C/W
Thermal Resistance, Junction to Case, Max for Diode	$R_{ heta JC}$	0.47	°C/W
Thermal Resistance, Junction to Ambient, Max	$R_{ heta JA}$	40	°C/W

### ELECTRICAL CHARACTERISTICS (T = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS	Pr					
Collector-emitter Breakdown Voltage, Gate-emitter Short-circuited	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1mA	BVces	1250	_	_	V
Temperature Coefficient of Breakdown Voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1mA	$\Delta BV_{CES} / \Delta T_J$	_	1.4	_	V/°C
Collector-emitter Cut-off Current, Gate-emitter Short-circuited	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = V <sub>CES</sub>	ICES	_	-	40	μΑ
Gate Leakage Current, Collector-emitter Short-circuited	V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0 V	IGES	-	-	±400	nA
ON CHARACTERISTICS						
Gate-emitter Threshold Voltage	$V_{GE} = V_{CE}$ , $I_C = 40 \text{ mA}$	VGE(th)	5.3	6.3	7.3	V
Collector-emitter Saturation Voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 175°C	VCE(sat)	_ _	1.75 2.09	2.1 -	V

## $\textbf{ELECTRICAL CHARACTERISTICS} \ (T_J = 25^{\circ}C \ unless \ otherwise \ specified) \ (continued)$

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
DYNAMIC CHARACTERISTICS	•	•			•	
Input Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>ies</sub>	_	8755	-	pF
Output Capacitance	1	C <sub>oes</sub>	_	302	-	
Reverse Transfer Capacitance	1	C <sub>res</sub>	_	162	-	
SWITCHING CHARACTERISTICS, INC	UCTIVE LOAD	•	-			
Turn-on Delay Time	T <sub>J</sub> = 25°C	t <sub>d(on)</sub>	_	43	-	ns
Rise Time	$V_{CC} = 600 \text{ V, } I_{C} = 20 \text{ A}$ Rg = 5 $\Omega$	t <sub>r</sub>	_	18	-	
Turn-off Delay Time	V <sub>GE</sub> = 15 V Inductive Load	t <sub>d(off)</sub>	_	222	-	
Fall Time		t <sub>f</sub>	_	53	-	
Turn-on Switching Loss	7	E <sub>on</sub>	_	1.6	-	mJ
Turn-off Switching Loss	1	E <sub>off</sub>		0.45	- ~	
Total Switching Loss	1	E <sub>ts</sub>	-	2.05	~10,	•
Turn-on Delay Time	T <sub>J</sub> = 25°C	t <sub>d(on)</sub>		48	<b>D</b> `_	ns
Rise Time	$V_{CC} = 600 \text{ V, } I_{C} = 40 \text{ A}$ $Rg = 5 \Omega$	t <sub>r</sub>		32	-	
Turn-off Delay Time	V <sub>GE</sub> = 15 V Inductive Load	t <sub>d(off)</sub>	NE	208	-	
Fall Time	madelive 25da	t <sub>f</sub>		68	-	
Turn-on Switching Loss		Eon	Stu.	3.4	-	mJ
Turn-off Switching Loss		E <sub>off</sub>	9-1	1.2	-	
Total Switching Loss	MD.	E <sub>ts</sub>	PAL	4.6	-	
Turn-on Delay Time	T <sub>J</sub> = 175°C	t <sub>d(øn)</sub>	_	40	-	ns
Rise Time	$V_{CC} = 600 \text{ V}, I_{C} = 20 \text{ A}$ $Rg = 5 \Omega$	Tt <sub>r</sub>	-	20	-	
Turn-off Delay Time	$V_{CC} = 600 \text{ V}, I_{C} = 20 \text{ A}$ $Rg = 5 \Omega$ $V_{GE} = 15 \text{ V}$ Inductive Load	t <sub>d(off)</sub>	-	252	-	
Fall Time	1 RUNII FO	t <sub>f</sub>	-	156	-	
Turn-on Switching Loss	70, CO, ME	E <sub>on</sub>	-	2.5	-	mJ
Turn-off Switching Loss	SE TAI	E <sub>off</sub>	-	1.08	-	
Total Switching Loss	CACHI	E <sub>ts</sub>	-	3.58	-	
Turn-on Delay Time	T <sub>J</sub> = 175°C	t <sub>d(on)</sub>	-	44	-	ns
Rise Time	$V_{CC} = 600 \text{ V}, I_{C} = 40 \text{ A}$ Rg = 5 $\Omega$	t <sub>r</sub>	-	32	-	
Turn-off Delay Time	V <sub>GE</sub> = 15 V Inductive Load	t <sub>d(off)</sub>	-	236	-	
Fall Time	1	t <sub>f</sub>	-	164	-	
Turn-on Switching Loss	1	E <sub>on</sub>	-	4.9	-	mJ
Turn-off Switching Loss	1	E <sub>off</sub>	_	2.5	-	
Total Switching Loss	1	E <sub>ts</sub>	-	7.4	-	
Total Gate Charge	V <sub>CE</sub> = 600 V, I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	Qg	-	395	-	nC
Gate to Emitter Charge	1	Q <sub>ge</sub>	-	72	-	
Gate to collector Charge		Q <sub>gc</sub>	-	198	-	
DIODE CHARACTERISTICS						
Forward Voltage	I <sub>F</sub> = 40 A, T <sub>J</sub> = 25°C I <sub>F</sub> = 40 A, T <sub>J</sub> = 175°C	V <sub>F</sub>	- -	1.51 1.54	2.0	V
Reverse Recovery Energy	T <sub>J</sub> = 25°C	E <sub>rec</sub>	-	0.74	-	mJ
Diode Reverse Recovery Time	$V_R = 600 \text{ V}, I_F = 20 \text{ A}$ $dI_F/dt = 1000 \text{ A}/\mu\text{s}$	T <sub>rr</sub>	-	143	_	ns
Diode Reverse Recovery Charge	7	Q <sub>rr</sub>	_	2546	-	nC

**ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified) (continued)

Parameter	neter Test Conditions		Min.	Тур.	Max.	Unit
DIODE CHARACTERISTICS	•	-				
Reverse Recovery Energy	T <sub>J</sub> = 25°C	E <sub>rec</sub>	-	1.14	_	mJ
Diode Reverse Recovery Time	$V_R = 600 \text{ V}, I_F = 40 \text{ A}$ $dI_F/dt = 1000 \text{ A}/\mu\text{s}$	T <sub>rr</sub>	-	195	-	ns
Diode Reverse Recovery Charge		Q <sub>rr</sub>	-	3761	-	nC
Reverse Recovery Energy	T <sub>J</sub> = 175°C	E <sub>rec</sub>	-	1.92	-	mJ
Diode Reverse Recovery Time	$V_R = 600 \text{ V}, I_F = 20 \text{ A}$ $dI_F/dt = 1000 \text{ A}/\mu\text{s}$	T <sub>rr</sub>	-	212	-	ns
Diode Reverse Recovery Charge		Q <sub>rr</sub>	-	5242	-	nC
Reverse Recovery Energy	T <sub>J</sub> = 175°C	E <sub>rec</sub>	-	2.768	-	mJ
Diode Reverse Recovery Time	V <sub>R</sub> = 600 V, I <sub>F</sub> = 40 A dI <sub>F</sub> /dt = 1000 A/μs	T <sub>rr</sub>	-	286	-	ns
Diode Reverse Recovery Charge		Q <sub>rr</sub>	-	7321	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Product parametric performance is indicated in the Electrical Characteristics if operated under different conditions.

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### **TYPICAL CHARACTERISTICS**

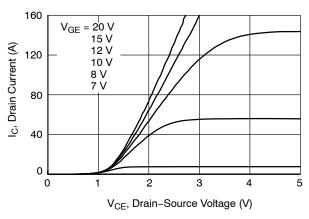


Figure 1. Typical Output Characteristics (25°C)

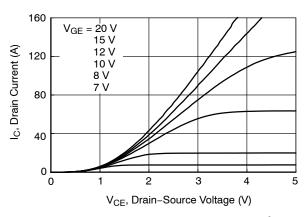


Figure 2. Typical Output Characteristics (175°C)

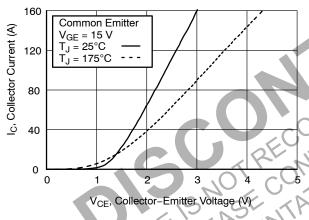


Figure 3. Typical Saturation Voltage Characteristics

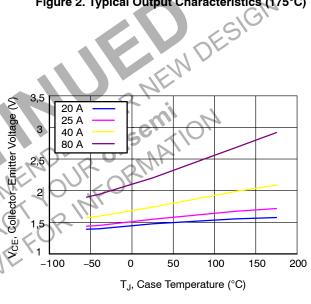


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

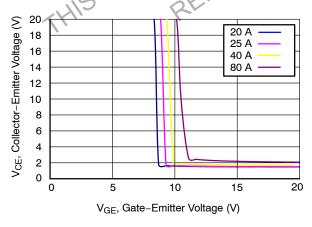


Figure 5. Saturation Voltage vs. V<sub>GE</sub> (25°C)

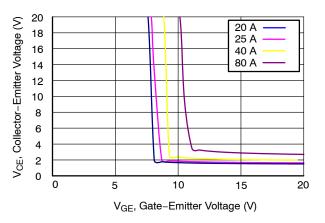


Figure 6. Saturation Voltage vs. V<sub>GE</sub> (175°C)

### TYPICAL CHARACTERISTICS (continued)

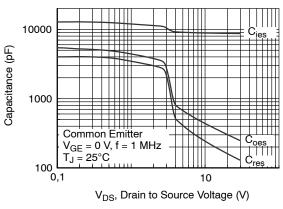


Figure 7. Capacitance Characteristics

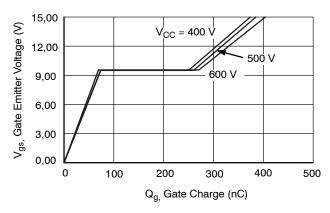
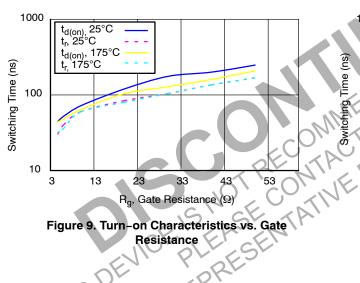


Figure 8. Gate Charge Characteristics



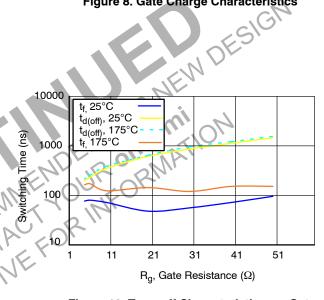


Figure 10. Turn-off Characteristics vs. Gate Resistance

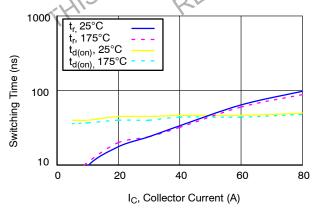


Figure 11. Turn-on Characteristics vs. Collector Current

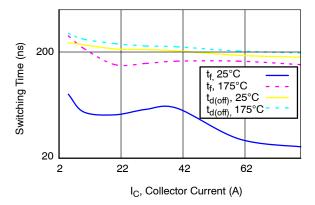


Figure 12. Turn-off Characteristics vs. Collector Current

### TYPICAL CHARACTERISTICS (continued)

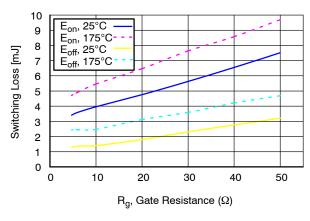


Figure 13. Switching Loss vs. Gate Resistance

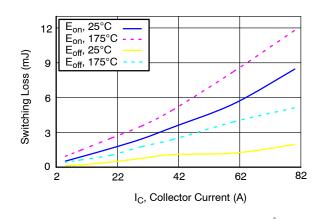


Figure 14. Switching Loss vs. Collector Current

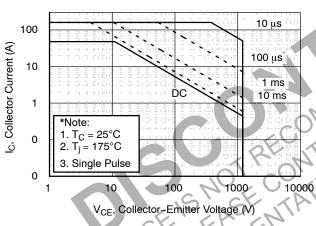


Figure 15. SOA Characteristics

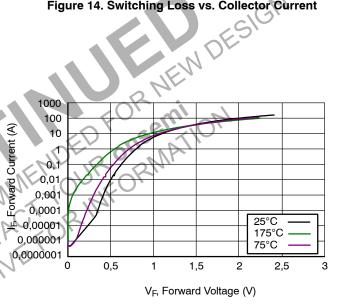


Figure 16. Forward Characteristics

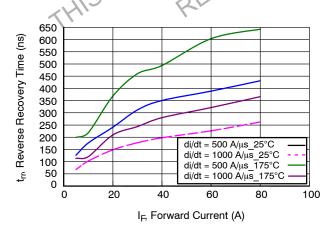


Figure 17. Reverse Recovery Time

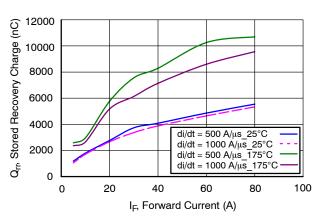


Figure 18. Stored Charge

### TYPICAL CHARACTERISTICS (continued)

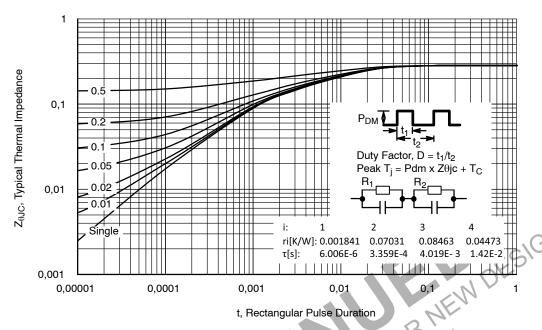


Figure 19. Transient Thermal Impedance of IGBT

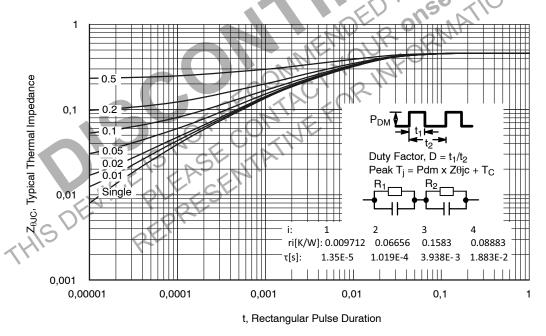


Figure 20. Transient Thermal Impedance of Diode

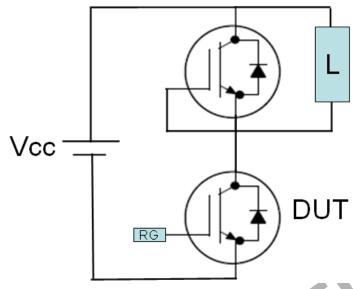


Figure 21. Test Circuit for Switching Characteristics

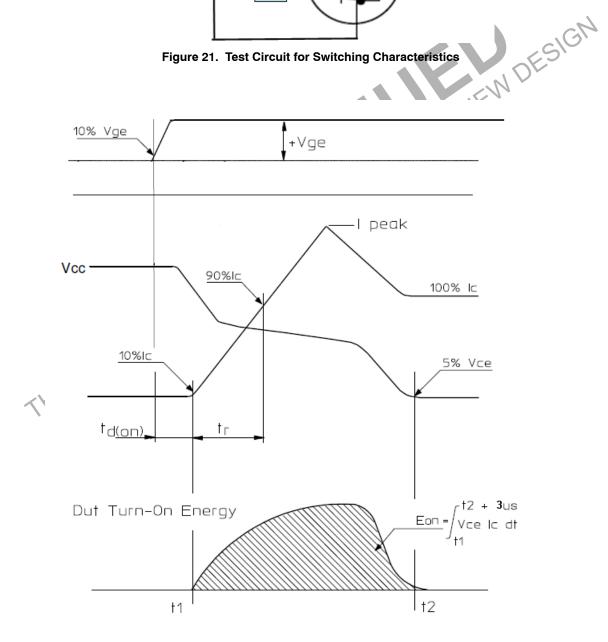
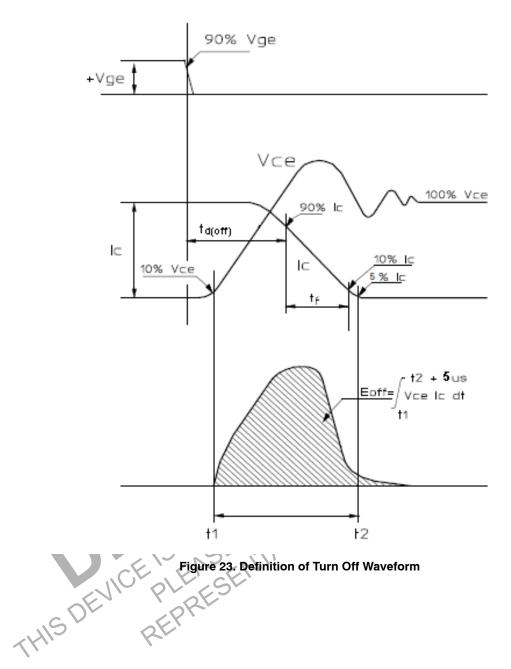
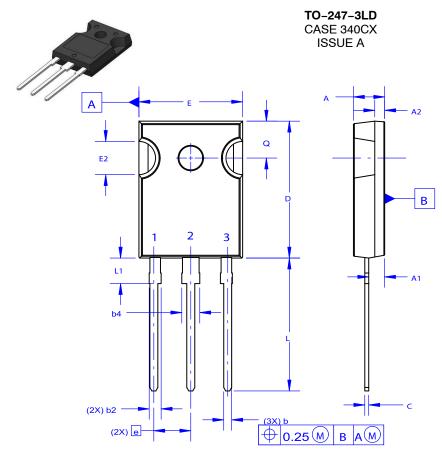


Figure 22. Definition of Turn On Waveform



**DATE 06 JUL 2020** 





NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

# GENERIC MARKING DIAGRAM\*



XXXXX = Specific Device Code A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

Ø <sub>P</sub> —		Φ <sub>P1</sub> D2
E1 —	2	D1
		I

DIM	MIL	LIMETER	S
DIM	MIN	NOM	MAX
Α	4.58	4.70	4.82
<b>A</b> 1	2.20	2.40	2.60
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.96	5.08	5.20
е	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
ØΡ	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
С	0.51	0.61	0.71
D1	13.08	~	~
D2	0.51	0.93	1.35
E1	12.81	~	~
ØP1	6.60	6.80	7.00

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DESCRIPTION:	TO-247-3LD		PAGE 1 OF 1	

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